TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π -MOSV)

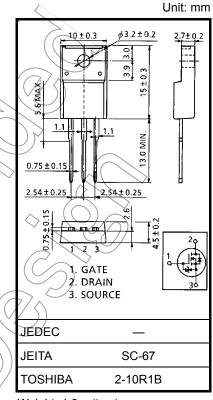
2SK3313

Chopper Regulator and DC–DC Converter Applications Motor Drive Applications

- Fast reverse recovery time : t_{rr} = 90 ns (typ.)
- Built-in high-speed free-wheeling diode
- Low drain-source ON-resistance : $R_{DS(ON)} = 0.5 \Omega$ (typ.)
- High forward transfer admittance : |Y_{fs}| = 8.5 S (typ.)
- Low leakage current $: I_{DSS} = 100 \ \mu A \ (max) \ (V_{DS} = 500 \ V)$
- Enhancement mode : V_{th} = 2.0 to 4.0 V (V_{DS} = 10 V, I_D = 1 mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage			V _{DSS}	500	y
Drain-gate voltage (R _{GS} = 20 kΩ)			V _{DGR}	500	> v
Gate-source voltage			V _{GSS}	±30	V
Drain current	DC (Note	: 1)	I _D	12	A
	Pulse (Note	: 1)	I _{DP} <	48	A
Drain power dissipation (Tc = 25°C)			PD	40	< w
Single pulse avalanche energy (Note 2)			EAS	324	mJ
Avalanche current				12	A
Repetitive avalanche energy (Note 3)			EAR	4.0	my
Channel temperature			$/\langle T_{ch}$	150	℃
Storage temperature range			T _{stg}	-55 to 150	℃



Weight: 1.9 g (typ.)

Note: Using continuously under heavy-loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics Symbol	Мах	Unit
Thermal resistance, channel to case Rth (ch-c)	3.125	°C / W
Thermal resistance, channel to ambient Rth (ch-a)	62.5	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 3.83 mH, R_G = 25 Ω , I_{AR} = 12 A

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.

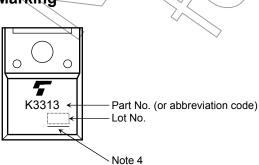
Electrical Characteristics (Ta = 25°C)

Charae	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	urrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μA
Gate-source br	eakdown voltage	V (BR) GSS	I _G = ±100 μA, V _{DS} = 0 V	±30		_	V
Drain cut-off cu	rrent	I _{DSS}	V _{DS} = 500 V, V _{GS} = 0 V	X	_	100	μA
Drain-source bi	reakdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	500	1	_	V
Gate threshold	voltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	2.0)/-	4.0	V
Drain-source O	N-resistance	R _{DS (ON)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 6 \text{ A}$	\sum	0.5	0.62	Ω
Forward transfe	r admittance	Y _{fs}	V _{DS} = 10 V, I _D = 6 A	3.0	8.5	-	S
Input capacitand	ce	C _{iss}			2040	-	
Reverse transfe	r capacitance	C _{rss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		210	_	pF
Output capacitance		C _{oss}			630		
Switching time	Rise time	tr	V_{GS}^{10V}	- (22		ns
	Turn-on time	t _{on}		U V	58) —	
	Fall time	t _f		$\langle \hat{\nabla} \rangle$) 36	_	
	Turn-off time	t _{off}	$V_{DD} = 200V$ Duty $\leq 1\%$, $t_{W} = 10\mu s$) -	180	_	
Total gate charg plus gate-drain	ge (Gate-source)	Qg		_	45	_	
Gate-source ch	arge	Q _{gs}	$V_{DD} \approx 400$ V, $V_{GS} = 10$ V, $I_D = 12$ A	_	25		nC
Gate-drain ("mi	ller") charge	Qgd		_	20	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)			_	_	12	А
Pulse drain reverse current (Note 1)		<u> </u>			48	А
Forward voltage (diode)	VDSF	I _{DR} = 12 A, V _{GS} = 0 V	-	-	-1.7	V
Reverse recovery time	trr	I _{DR} = 12 A, V _{GS} = 0 V		90	160	ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 100 Å / μs		0.25	_	μC



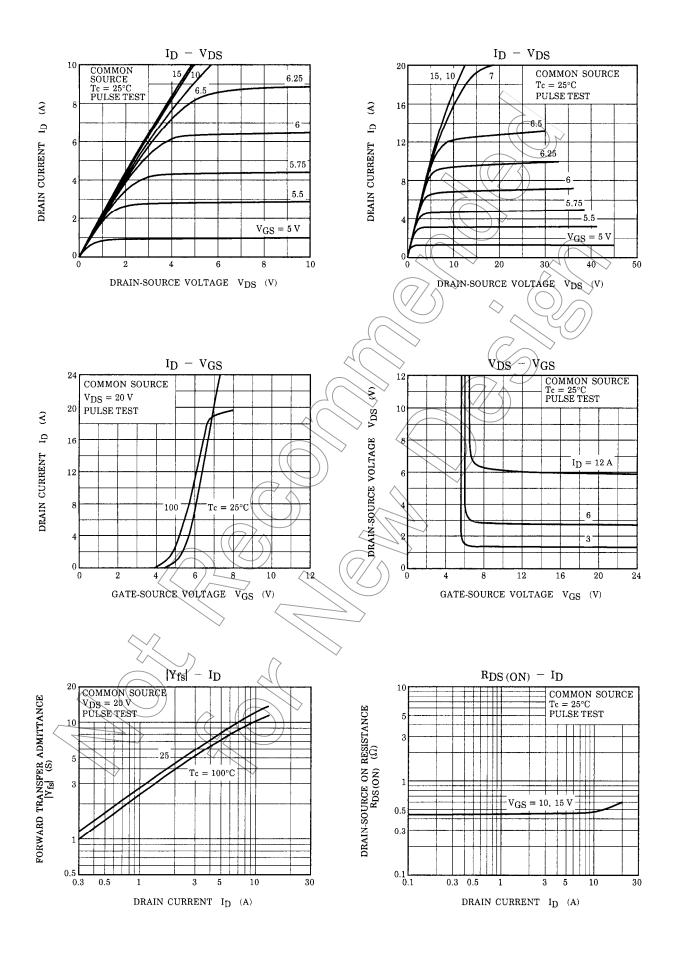


Note 4: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV

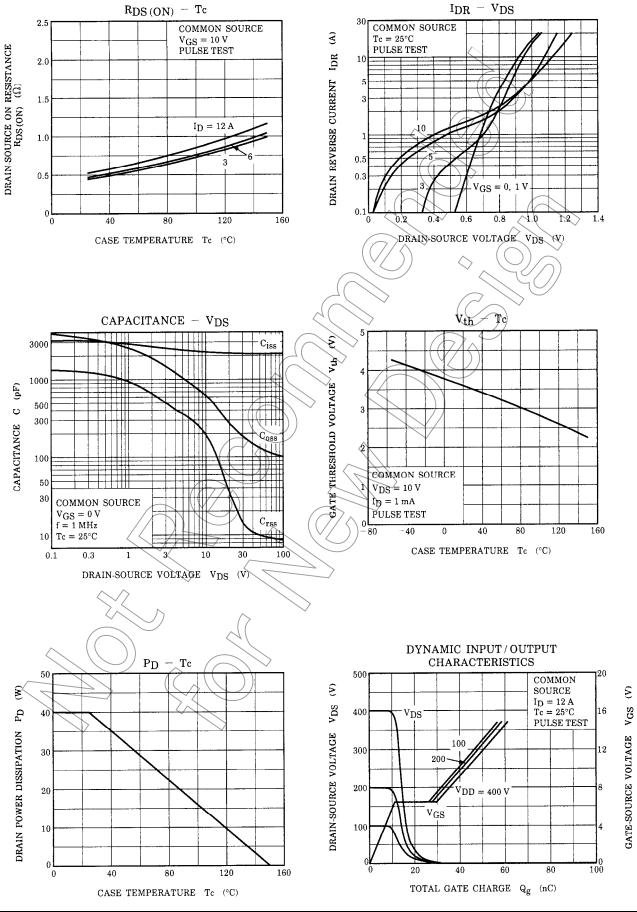
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

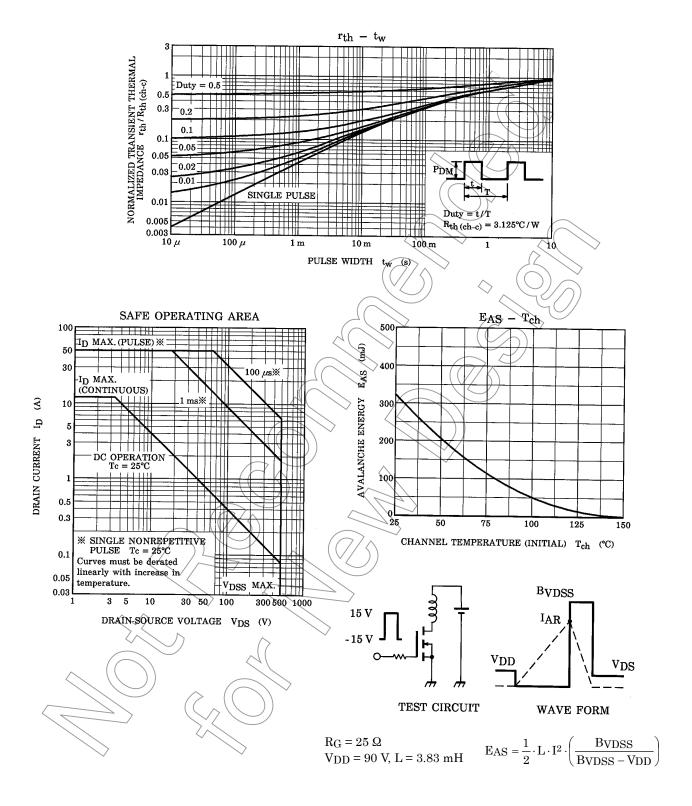
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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